Ninaad Bhan

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EDUCATION

Manipal University Jaipur

Jaipur, India

Bachelor of Technology in Mechatronics Engineering; GPA: 7.42 /10.0

July 2014 - June 2018

SKILLS

- Languages: Python (scikit-learn, NumPy, SciPy, Pandas, OpenCV), C++, R
- Softwares: MATLAB & Simulink, LabVIEW, Creo, Keil
- Developement Board: Arduino, Rspberry Pi
- Academic: Pneumatic & Hydraulics, Fuzzy Logic, Artificial Neural Systems, Sensors, Robotics, Microelectromechanical Systems, Microcontrollers & microprocessors, Composite Materials, Control Systems

Projects

• 3D Printer

- Designing and modelling of square-shaped and cantilever structured 3D printer using Creo.
- o Circuit designing of sensors and actuators using microcontroller Arduino Mega and MKS gen controller
- Coding and implementation of **firmware** using parameters like vibration, temprature, etc.

• LEGO LabVIEW Projects

- Optimized line follower with single infrared sensor using PID Programming.
- Spying self-balancing robot using gyroscope sensor and PID Programming with camera.

• Autonomous Robotic Arm

o Designed, hand crafted and programmed an autonomous robotic arm with 3 degrees of freedom with 5 finger clampers using servo motors and sensors with Arduino Environment.

• PLC Simulation

• Design and simulation of Hydro power plant using Seimens PLC.

Research Papers

- Importance of Cantilever shaped Polar 3D, The International Conference of Start-Up Ventures: Technology Development and Future Strategies (SV-TDFS), 2018
- Importance of Cantilever shaped Polar 3D printers as new standard for desktop 3D printers, Submitted for publishing

EXPERIENCE

 $Co ext{-}Founder$

Magal Tech. Engg. Pvt. Ltd

Chennai, India

Intern

June 2017 - July 2017

• Indepth study of the Automated Thermostat Calibrating Machine and presenting ideas for improvement.

VoidWorks(Purinto)

College-Level Startup, Manipal University

Feb. 2018 - Jun.2018

- 3D printing services for the university and the regional market.
- Tackling common problems related to filament re-utilization and 3D object scanning.